

## Silicon TVS diodes Array

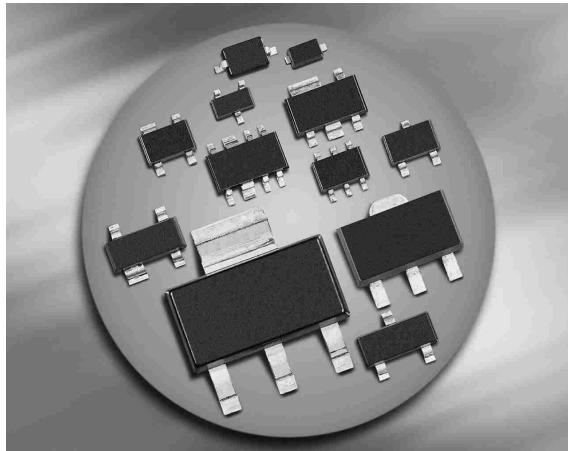
- ESD / transient protection of e.g. ADSL, VDSL, ISDN, WAN, LAN, I<sup>2</sup>C Bus, Microcontroller Inputs, Video and other high-speed data lines in telecom applications:

IEC61000-4-2 (ESD):  $\pm 15$  kV (Air / Contact)

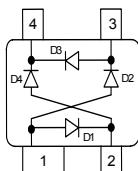
IEC61000-4-4 (EFT): 4 kV / 80 A (5/50 ns)

IEC61000-4-5 (Lightning): 27 A (8/20  $\mu$ s)

- Very low capacitance
- Extremely low reverse current < 5 nA
- Pb-free (RoHS compliant) package



## DSL70



| Type  | Package | Configuration           | Marking |
|-------|---------|-------------------------|---------|
| DSL70 | SOT143  | 2 channel, rail to rail | E4s     |

**Maximum Ratings** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter  | Symbol           | Value     | Unit             |
|--|------------------|-----------|------------------|
| ESD contact discharge per diode <sup>1</sup> )                   | $V_{\text{ESD}}$ | 15        | kV               |
| Peak pulse current ( $t_p = 8 / 20 \mu\text{s}$ ) <sup>2</sup> ) | $I_{\text{pp}}$  | 27        | A                |
| Peak pulse power ( $t_p = 8 / 20 \mu\text{s}$ )                  | $P_{\text{pk}}$  | 245       | W                |
| Operating temperature range                                      | $T_{\text{op}}$  | -55...125 | $^\circ\text{C}$ |
| Storage temperature  | $T_{\text{stg}}$ | -65...150 |                  |

<sup>1</sup> $V_{\text{ESD}}$  according to IEC61000-4-2

<sup>2</sup> $I_{\text{pp}}$  according to IEC61000-4-5

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

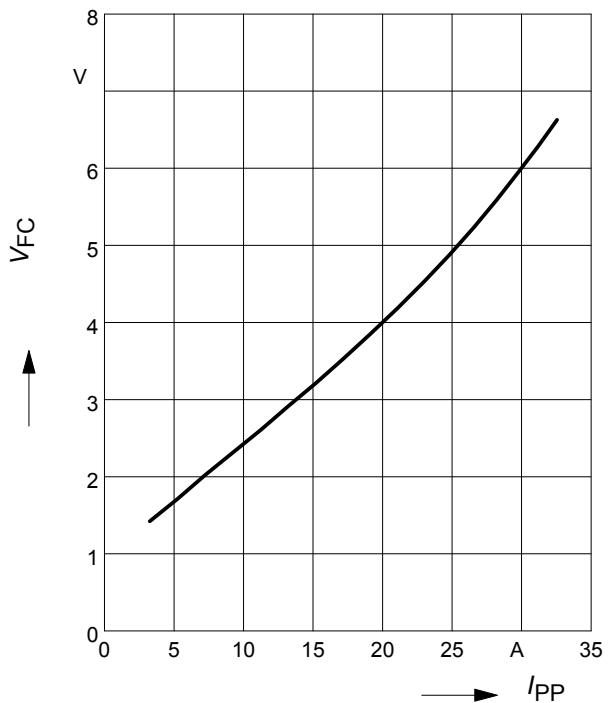
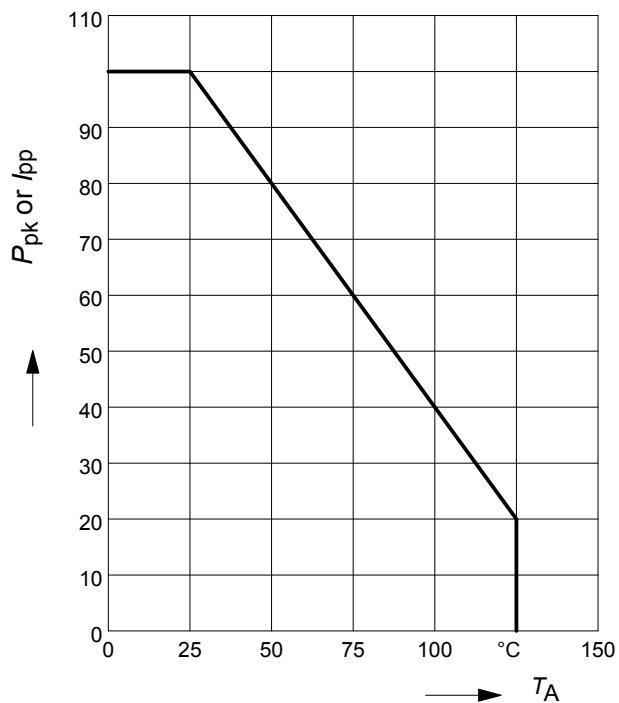
| Parameter   | Symbol    | Values |      |      | Unit |
|---|-----------|--------|------|------|------|
|   |           | min.   | typ. | max. |      |
| <b>Characteristics -</b>  |           |        |      |      |      |
| Reverse working voltage   | $V_{RWM}$ | -      | -    | 50   | V    |
| Reverse current<br>$V_R = 50\text{ V}$  | $I_R$     | -      | -    | 5    | nA   |
| Forward clamping voltage <sup>1)</sup><br>$I_{PP} = 1\text{ A}, t_P = 8/20\text{ }\mu\text{s}$<br>$I_{PP} = 10\text{ A}, t_P = 8/20\text{ }\mu\text{s}$<br>$I_{PP} = 24\text{ A}, t_P = 8/20\text{ }\mu\text{s}$<br>$I_{PP} = 27\text{ A}, t_P = 8/20\text{ }\mu\text{s}$ | $V_{FC}$  | -      | 1    | 1.5  | V    |
| -   | -         | -      | 2.5  | 3    |      |
| -   | -         | -      | 5    | 6    |      |
| -   | -         | -      | 6    | 9    |      |
| Diode capacitance<br>$V_R = 0\text{ V}, f = 1\text{ MHz, between I/O and GND}$<br>$V_R = 0\text{ V}, f = 1\text{ MHz, between I/O pins}$  | $C_T$     | -      | 2.5  | 5    | pF   |
|   |           | -      | 1.25 | 2.5  |      |

<sup>1)</sup> $I_{PP}$  according to IEC61000-4-5

**Power derating curve  $P_{pk} = f(T_A)$**

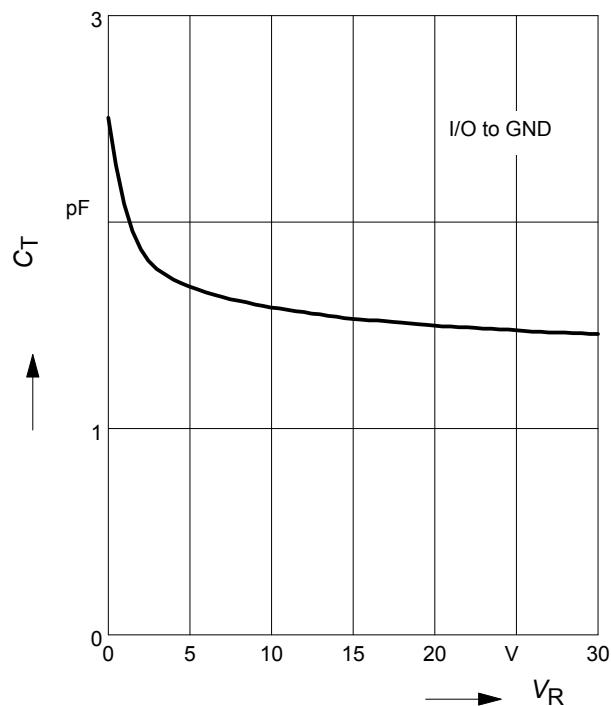
**Forward clamping voltage  $V_{FC} = f(I_{PP})$**

$t_p = 8 / 20 \mu\text{s}$



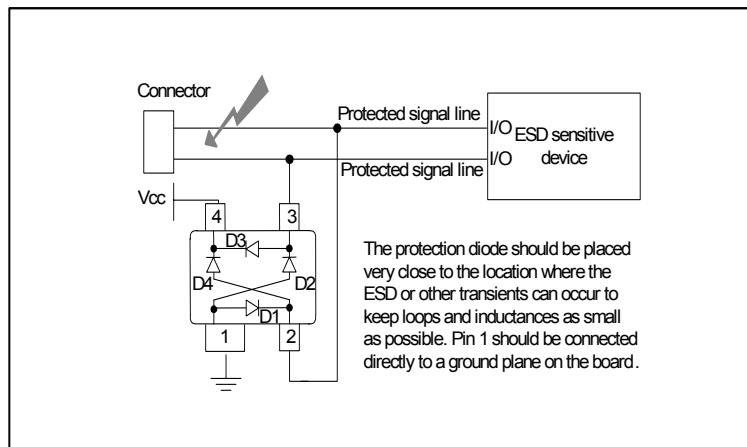
**Diode capacitance  $C_T = f(V_R)$**

$f = 1\text{MHz}$

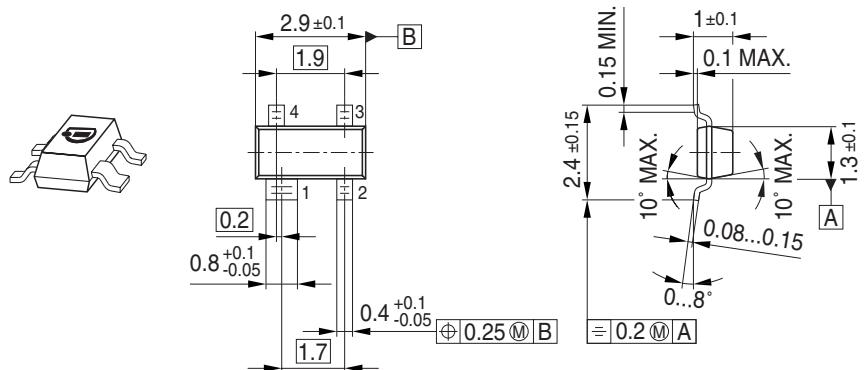


## Application example DSL70

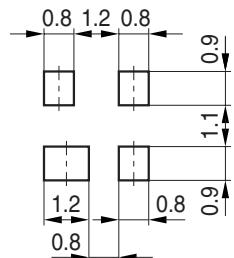
dual channel, rail to rail configuration



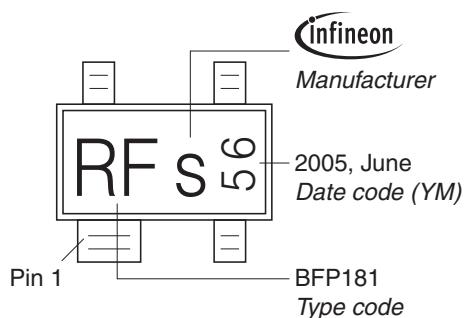
## Package Outline



## Foot Print

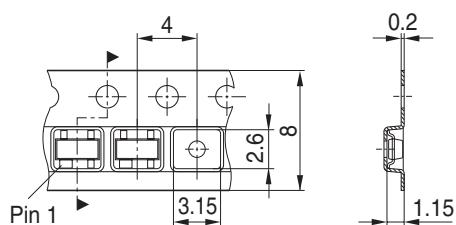


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
 Reel ø330 mm = 10.000 Pieces/Reel



---

**Edition 2009-11-16**

**Published by**  
**Infineon Technologies AG**  
**81726 Munich, Germany**

**© 2009 Infineon Technologies AG**  
**All Rights Reserved.**

### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

### **Information**

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([www.infineon.com](http://www.infineon.com)).

### **Warnings**

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.